- Phase-Locked Loop-Based Multiplier by Four
- Input Frequency Range: 2.5 MHz to 45 MHz
- Output Frequency Range: $10 \mathbf{M H z}$ to 180 MHz
- LVCMOS/LVTTL I/O Compatible
- Low Jitter (Cycle-Cycle): $\pm 120$ ps Over the Range 75 MHz to 180 MHz
- Distributes One Clock Input to Two Banks of Four Outputs
- Auto Frequency Detection to Disable Device (Power-Down Mode)
- Operates From Single 3.3-V Supply
- Industrial Temperature Range $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
- 25- $\Omega$ On-Chip Series Damping Resistors
- No External RC Network Required
- Spread Spectrum Clock Compatible (SSC)
- Available in 16-Pin TSSOP Package


## description

The CDCVF25084 is a high-performance, low-skew, low-jitter, phase-lock loop clock multiplier. It uses a PLL to precisely align, in both frequency and phase, the output clocks to the input clock signal including a multiplication factor of four. The CDCVF25084 operates from a nominal supply voltage of 3.3 V . The device also includes integrated series-damping resistors in the output drivers that make it ideal for driving point-to-point loads.

Two banks of four outputs each provide low-skew, low-jitter copies of CLKIN x four. All outputs operate at the same frequency. Output duty cycles are adjusted to $50 \%$, independent of duty cycle at CLKIN. The device automatically goes into power-down mode when no input signal is applied to CLKIN and the outputs go into a low state. Unlike many products containing PLLs, the CDCVF25084 does not require an external RC network. The loop filter for the PLL is included on-chip, minimizing component count, space, and cost.
Because it is based on a PLL circuitry, the CDCVF25084 requires a stabilization time to achieve phase lock of the feedback signal to the reference signal. This stabilization is required following power up and application of a fixed-frequency signal at CLKIN and any following changes to the PLL reference.

The CDCVF25084 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.
FUNCTION TABLE

| S2 | S1 | 1Y0-1Y3 | 2Y0-2Y3 | OUTPUT SOURCE | PLL SHUTDOWN |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Hi-Z | Hi-Z | N/A | Yes |
| 0 | 1 | Active | Hi-Z | PLL $\dagger$ | No |
| 1 | 0 | Active | Active | Input clock (PLL bypass) | Yes |
| 1 | 1 | Active | Active | PLL $\dagger$ | No |

$\dagger$ A CLK input frequency $<2 \mathrm{MHz}$ switches the outputs to low level.

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## 3.3-V 1:8 ZERO DELAY (PLL) x4 CLOCK MULTIPLIER

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## Terminal Functions

| TERMINAL |  | TYPE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| NAME | PIN NO. |  |  |
| 1Y[0:3] | 2, 3, 14, 15 | O | Bank 1Yn clock outputs. These outputs are low-skew copies of CLKIN. Each output has an integrated $25-\Omega$ series-damping resistor. |
| 2Y[0:3] | $6,7,10,11$ | O | Bank 2 Yn clock outputs. These outputs are low-skew copies of CLKIN. Each output has an integrated $25-\Omega$ series-damping resistor. |
| CLKIN | 1 | I | Clock input. CLKIN provides the clock signal to be distributed by the CDCVF25084 clock driver. CLKIN is used to provide the reference signal to the integrated PLL that generates the output signal. CLKIN must have a fixed frequency and phase in order for the PLL to acquire lock. Once the circuit is powered up and a valid signal is applied, a stabilization time is required for the PLL to phase lock the feedback signal to CLKIN. |
| FBIN | 16 | I | Feedback input. FBIN provides the feedback signal to the internal PLL. FBIN must be wired to one of the outputs to complete the feedback loop of the internal PLL. The integrated PLL synchronizes the FBIN and output signal so there is nominally zero-delay from input clock to output clock. |
| GND | 5,12 | Ground | Ground |
| S1, S2 | 9, 8 | I | Select pins to determine mode of operation. See the FUNCTION TABLE for mode selection options. |
| VDD | 4, 13 | Power | Supply voltage. The supply voltage range is 3 V to 3.6 V |

## functional block diagram



## CDCVF25084

## 3.3-V 1:8 ZERO DELAY (PLL) x4 CLOCK MULTIPLIER

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## absolute maximum ratings over operating free-air temperature (unless otherwise noted) $\dagger$


$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output negative voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.
recommended operating conditions

|  | MIN | NOM |
| :--- | ---: | :---: |
|  | MAX | UNIT |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ | 3 | 3.3 |
| Low level input voltage, $\mathrm{V}_{\mathrm{IL}}$ | 3.6 | V |
| High level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | 2 | 0.8 |
| Input voltage, $\mathrm{V}_{\mathrm{I}}$ | V |  |
| High-level output current, $\mathrm{IOH}_{\mathrm{OH}}$ | 0 | V |
| Low-level output current, IOL |  | 3.6 |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | V |  |

timing requirements over recommended ranges of supply voltage, load and operating free-air temperature

|  | MIN | NOM | MAX |
| :--- | ---: | ---: | ---: |
| UNIT |  |  |  |
| Input clock frequency, fCLKIN | 2.5 | 45 | MHz |
| Input clock duty cycle | $40 \%$ | $60 \%$ |  |
| Clock frequency, $\mathrm{f}_{\text {clkout }}$ | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 10 | 180 |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | MIN | TYPt | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IK }}$ | Input voltage | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{I}=-18 \mathrm{~mA}$ |  |  | -1.2 | V |
| I | Input current | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  |  | $\pm 5$ | $\mu \mathrm{A}$ |
| IPD | Power-down current | $\mathrm{f}^{\text {CLKIN }}=0 \mathrm{MHz}$, | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $\mathrm{lDD}^{\ddagger}$ | Dynamic current | $\mathrm{f}_{\text {out }}=80 \mathrm{MHz}$, | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 60 | 80 | mA |
| loz | Output 3-state | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$, | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$ |  |  | $\pm 5$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | Input capacitance at FBIN, CLKIN | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 4 |  | pF |
| $\mathrm{C}_{1}$ | Input capacitance at S1, S2 | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 2.2 |  | pF |
| $\mathrm{Co}^{\circ}$ | Output capacitance | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 3 |  | pF |
| VOH | High-level output voltage | $\mathrm{V}_{\mathrm{DD}}=$ min to max, | $\mathrm{IOH}=-100 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{DD}}-0.2$ |  |  | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA}$ | 2.1 |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{IOH}=-6 \mathrm{~mA}$ | 2.4 |  |  |  |
| VOL | Low-level output voltage | $\mathrm{V}_{\mathrm{DD}}=$ min to max, | $\mathrm{l} \mathrm{OL}=100 \mu \mathrm{~A}$ |  |  | 0.2 | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{IOL}=12 \mathrm{~mA}$ |  |  | 0.8 |  |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OL}}=6 \mathrm{~mA}$ |  |  | 0.55 |  |
| ${ }^{\text {IOH }}$ | High-level output current | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=1 \mathrm{~V}$ | -24 |  |  | mA |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=1.65 \mathrm{~V}$ |  | -30 |  |  |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=3.135 \mathrm{~V}$ |  |  | -15 |  |
| ${ }^{\text {IOL }}$ | Low-level output current | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=1.95 \mathrm{~V}$ | 26 |  |  | mA |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=1.65 \mathrm{~V}$ |  | 33 |  |  |
|  |  | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}$ |  |  | 14 |  |

$\dagger$ All typical values are at respective nominal $V_{D D}$.
$\ddagger$ All outputs are switching; for IDD over frequency see Figure 9.

## 3.3-V 1:8 ZERO DELAY (PLL) x4 CLOCK MULTIPLIER

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYPt MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| t (lock) | PLL lock time | $\mathrm{f}_{\text {out }}=100 \mathrm{MHz}$ |  | 2 | $\mu \mathrm{s}$ |
| t(phoffset) | Phase offset (CLKIN to FBIN), (see Note 5) | $\mathrm{f}_{\text {out }}=40 \mathrm{MHz}$ to 75 MHz , Vth $=\mathrm{V}_{\text {DD }} / 2$ |  | $\pm 200$ | ps |
|  |  | $\mathrm{f}_{\text {out }}=75 \mathrm{MHz}$ to 180 MHz , Vth $=\mathrm{V}_{\mathrm{DD}} / 2$ |  | $\pm 100$ |  |
| tPLH, tPHL | Propagation delay | S2 = High, S1 = Low (PLL bypass mode) | 2.3 | 4.5 | ns |
| tsk(0) | Output skew (Yn to Yn) (see Note 4) | See Figure 3 |  | $75 \quad 150$ | ps |
| $\mathrm{t}_{\text {sk }}(\mathrm{pp})$ | Part-to-part skew (low-to-high transition) | PLL bypass mode |  | 900 | ps |
|  |  | PLL mode, $\mathrm{f}_{\text {out }}=40 \mathrm{MHz}$ to 75 MHz |  | 350 |  |
|  |  | PLL mode, $\mathrm{f}_{\text {out }}=75 \mathrm{MHz}$ to 180 MHz |  | 300 |  |
| tiji(cc) | Jitter (cycle-to-cycle) | $\mathrm{f}_{\text {out }}=40 \mathrm{MHz}$ to 75 MHz |  | $\pm 220$ | ps |
|  |  | $\mathrm{f}_{\text {out }}=75 \mathrm{MHz}$ to 180 MHz |  | $\pm 120$ | ps |
| tijit(per) | Period jitter | $\mathrm{f}_{\text {out }}=40 \mathrm{MHz}$ to 75 MHz |  | 260 | ps |
|  |  | $\mathrm{f}_{\text {out }}=75 \mathrm{MHz}$ to 180 MHz |  | 140 | ps |
| $\left.\mathrm{tijit}^{( }\right)$) | Phase jitter | fout $=75 \mathrm{MHz}$ to 180 MHz , peak-to-peak (see Note 6) |  | $\pm 110$ | ps |
|  |  | $\mathrm{f}_{\text {out }}=75 \mathrm{MHz}$ to 180 MHz , RMS (see Note 6) |  | 26 | ps |
| odc | Output duty cycle | $\mathrm{f}_{\text {out }}=10 \mathrm{MHz}$ to 180 MHz | 45\% | 55\% |  |
| $\mathrm{t}_{\text {sk }}(\mathrm{p})$ | Pulse skew | S2 = High, S1 = low (PLL bypass mode) |  | 0.3 | ns |
| $\mathrm{tr}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Rise / fall time rate | See Figure 4 | 1 | 3 | $\mathrm{V} / \mathrm{ns}$ |

$\dagger$ All typical values are at respective nominal $V_{D D}$.
NOTES: 4. The $\mathrm{t}_{\mathrm{sk}}(0)$ specification is only valid for equal loading of all outputs.
5. Similar waveform at CLKIN and FBIN are required. Output 1 Y 3 is used as a feedback to FBIN loaded with 11 pF and all other outputs have 15 pF . For phase displacement between CLKIN and Y-outputs, see Figure 5.
6. Input phase jitter $< \pm 50 \mathrm{ps}$; output sample size is 20000 cycles.

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: $Z_{O}=50 \Omega, t_{r}<1.2 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}}<1.2 \mathrm{~ns}$
C. The outputs are measured one at a time with one transition per measurement.

Figure 1. Test Load Circuit


Figure 2. Voltage Thresholds for Measurements, Phase Offset (PLL Mode)


NOTE: $\quad$ odc $=t_{1} /\left(t_{1}+t_{2}\right) \times 100 \%$
Figure 3. Output Skew and Output Duty Cycle (PLL Mode)

## 3.3-V 1:8 ZERO DELAY (PLL) x4 CLOCK MULTIPLIER



NOTE: $\mathrm{t}_{\mathrm{sk}}(\mathrm{p})=|\mathrm{tpLh}-\mathrm{tpHL}|$
Figure 4. Propagation Delay and Pulse Skew (Non-PLL Mode)


Figure 5

PHASE OFFSET
vs
FREQUENCY


Figure 6

## PARAMETER MEASUREMENT INFORMATION

CYCLE-TO-CYCLE / PERIOD JITTER
vs
FREQUENCY


Figure 7

TRANSFER CHARACTERISTIC FROM CLKIN TO Yn


Figure 8


Figure 9

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CDCVF25084PW | ACTIVE | TSSOP | PW | 16 | 90 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | CK084 | Samples |
| CDCVF25084PWR | ACTIVE | TSSOP | PW | 16 | 2000 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | CK084 | Samples |
| CDCVF25084PWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | RoHS \& Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | CK084 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000 \mathrm{ppm}$ threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CDCVF25084PWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CDCVF25084PWR | TSSOP | PW | 16 | 2000 | 853.0 | 449.0 | 35.0 |



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.


NOTES: (continued)
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.


SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL SCALE: 10X

NOTES: (continued)
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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